

HD74LS12

Triple 3-input Positive NAND Gates (with Open Collector Output)

REJ03D0398-0200

Rev.2.00

Feb.18.2005

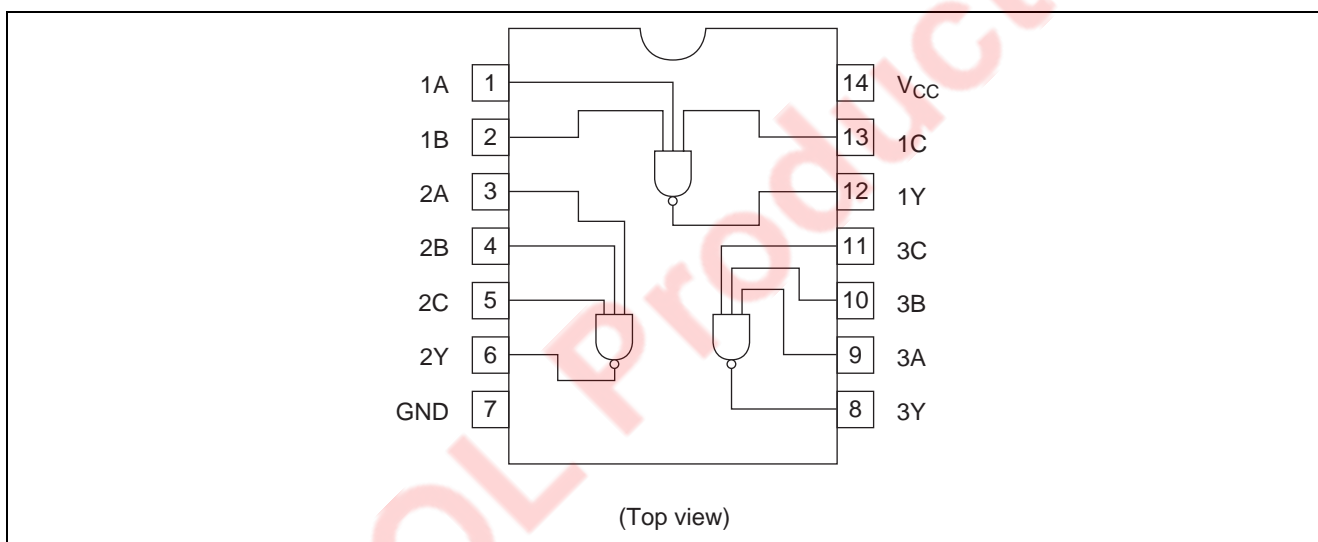
Features

- Ordering Information

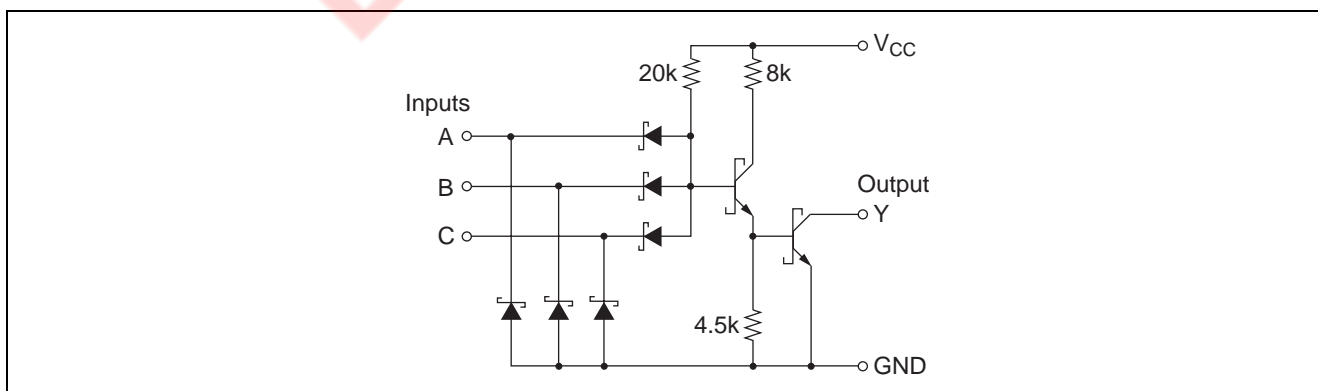
Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS12P	DILP-14 pin	PRDP0014AB-B (DP-14AV)	P	—

Note: Please consult the sales office for the above package availability.

Pin Arrangement



Circuit Schematic (1/3)



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	V_{CC}	7	V
Input voltage	V_{IN}	7	V
Power dissipation	P_T	400	mW
Storage temperature	T_{stg}	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

Item	Symbol	Min	Typ	Max	Unit
Supply voltage	V_{CC}	4.75	5.00	5.25	V
Output voltage	V_{OH}	—	—	5.5	V
Output current	I_{OL}	—	—	8	mA
Operating temperature	T_{opr}	-20	25	75	°C

Electrical Characteristics

($T_a = -20$ to $+75$ °C)

Item	Symbol	min.	typ.*	max.	Unit	Condition
Input voltage	V_{IH}	2.0	—	—	V	
	V_{IL}	—	—	0.8	V	
Output voltage	V_{OL}	—	—	0.5	V	$V_{CC} = 4.75$ V, $V_{IH} = 2$ V
		—	—	0.4		
Output current	I_{OH}	—	—	100	μA	$V_{CC} = 4.75$ V, $V_{IL} = 0.8$ V, $V_{OH} = 5.5$ V
Input current	I_{IH}	—	—	20	μA	$V_{CC} = 5.25$ V, $V_I = 2.7$ V
	I_{IL}	—	—	-0.4	mA	$V_{CC} = 5.25$ V, $V_I = 0.4$ V
	I_I	—	—	0.1	mA	$V_{CC} = 5.25$ V, $V_I = 7$ V
Supply current	I_{CCH}	—	0.7	1.4	mA	$V_{CC} = 5.25$ V
	I_{CCL}	—	1.8	3.3	mA	$V_{CC} = 5.25$ V
Input clamp voltage	V_{IK}	—	—	-1.5	V	$V_{CC} = 4.75$ V, $I_{IN} = -18$ mA

Note: * $V_{CC} = 5$ V, $T_a = 25$ °C

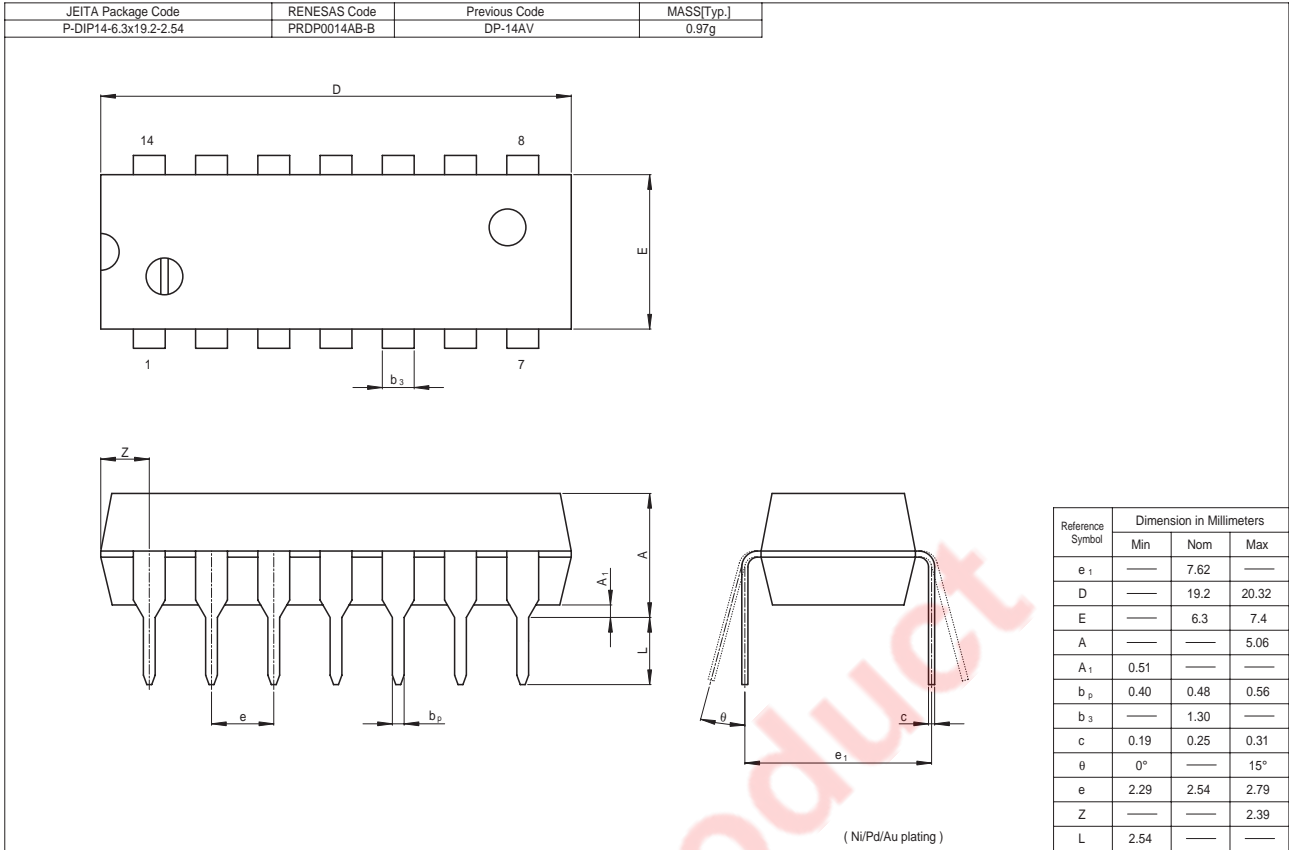
Switching Characteristics

($V_{CC} = 5$ V, $T_a = 25$ °C)

Item	Symbol	min.	typ.	max.	Unit	Condition
Propagation delay time	t_{PLH}	—	17	32	ns	$C_L = 15$ pF, $R_L = 2$ kΩ
	t_{PHL}	—	15	28	ns	

Note: Refer to Test Circuit and Waveform of the Common Item "TTL Common Matter (Document No.: REJ27D0005-0100)".

Package Dimensions



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